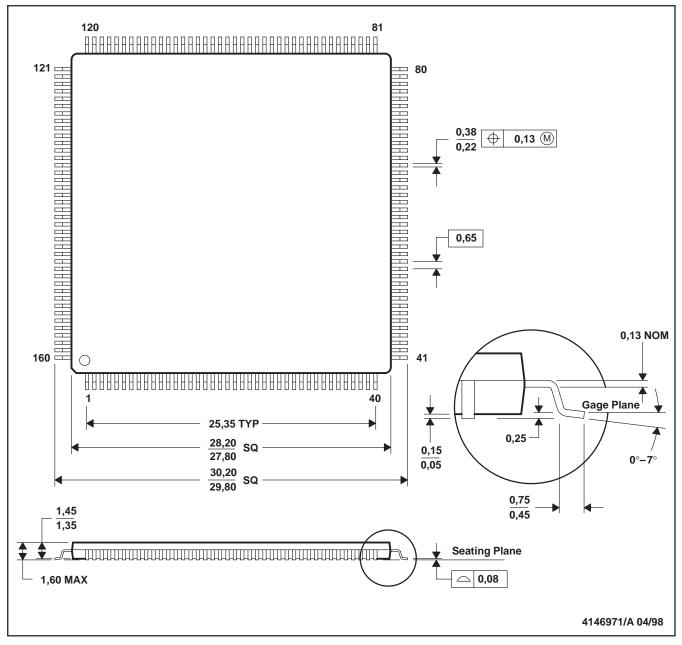
MECHANICAL DATA

MPQF076 – JANUARY 1998

PSF (S-PQFP-G160)

PLASTIC QUAD FLATPACK



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-026



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